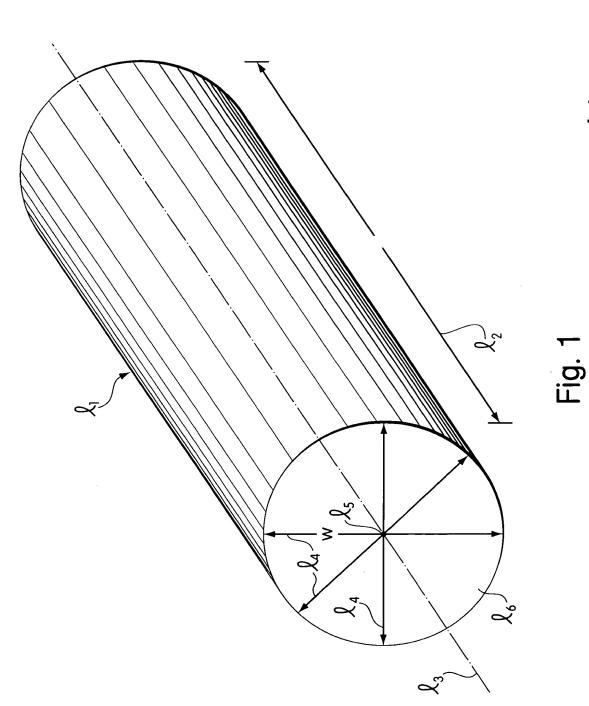


1/43



O9935776 O31898





2/43

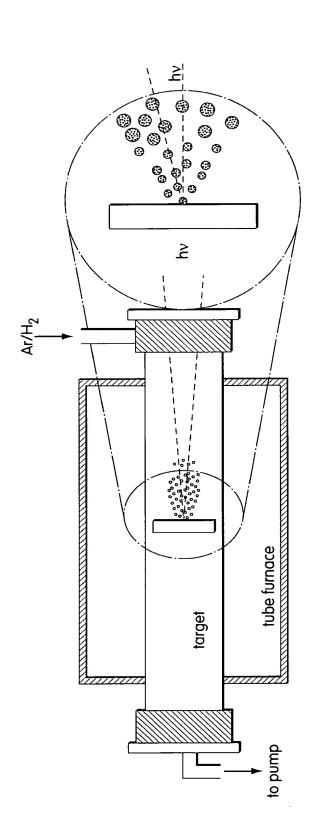


Fig. 2





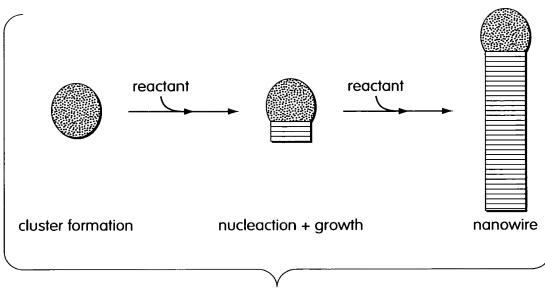


Fig. 3

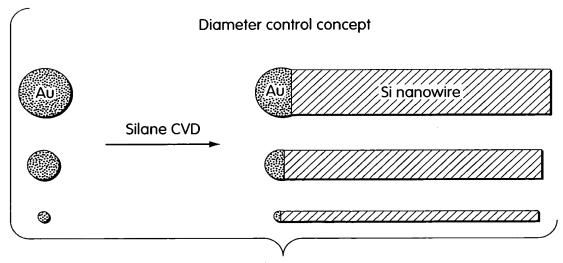
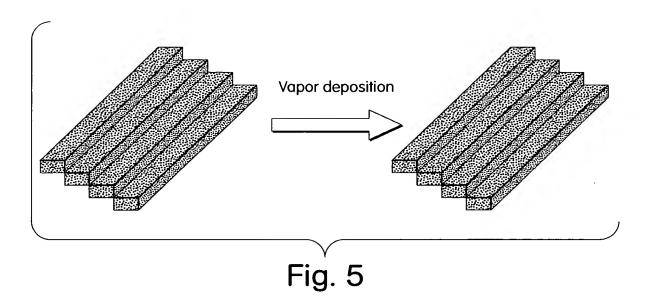


Fig. 4







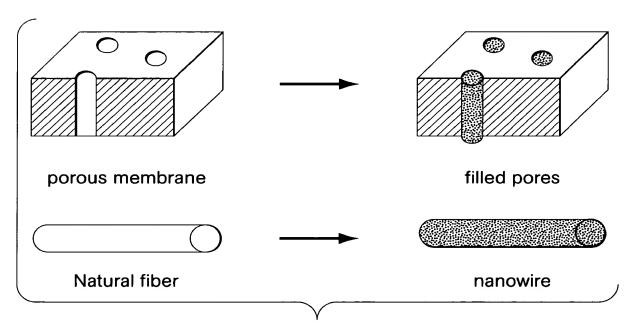


Fig. 6

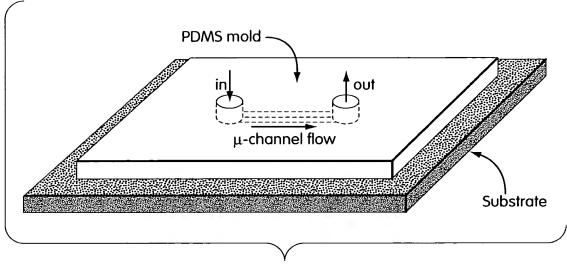


Fig. 7A

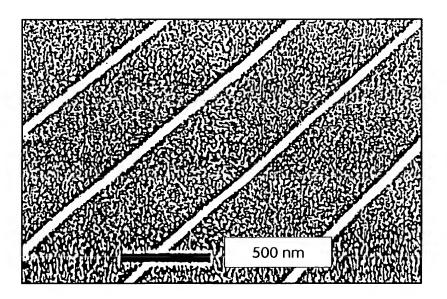
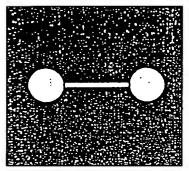


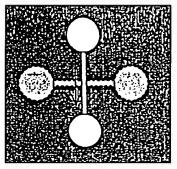
Fig. 7B





First layer

Fig. 7C



Second layer

Fig. 7D

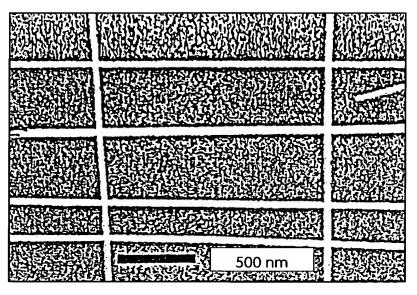
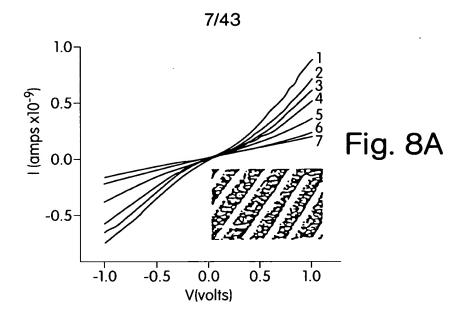
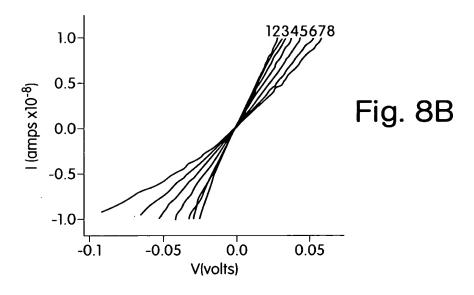
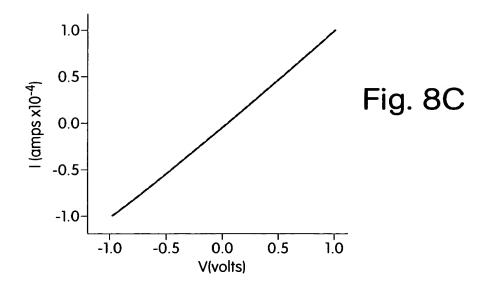


Fig. 7E







8/43

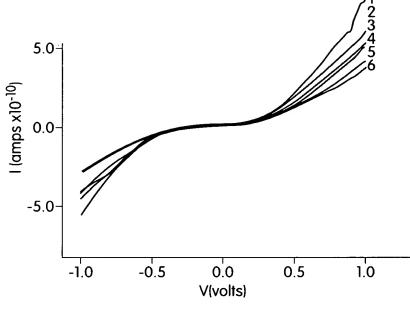


Fig. 9A

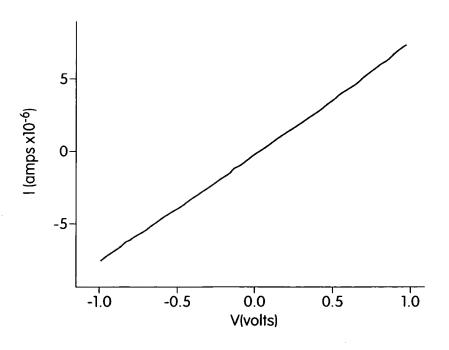
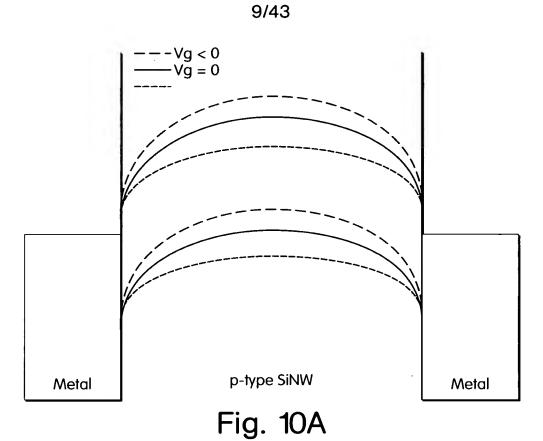


Fig. 9B

O935776.Calaoe



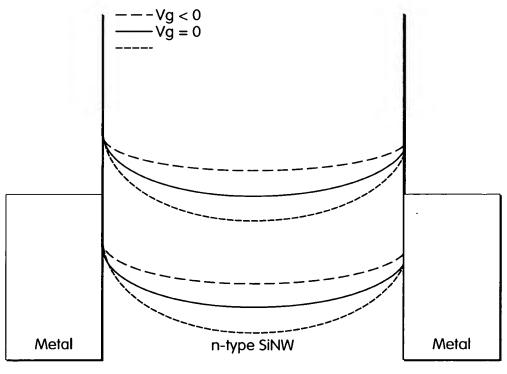


Fig. 10B



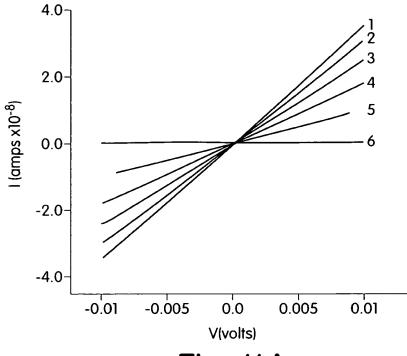


Fig. 11A

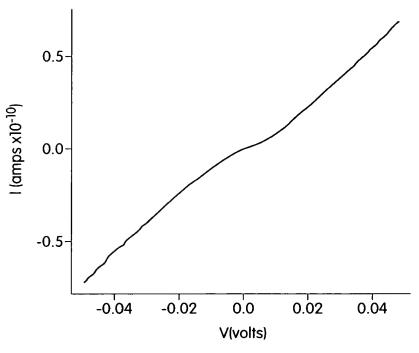
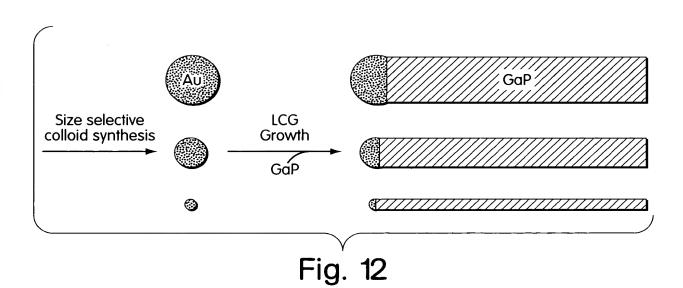


Fig. 11B





· .

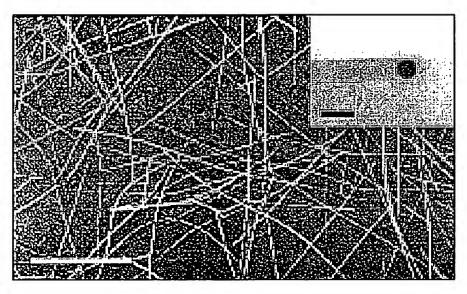


Fig. 13A

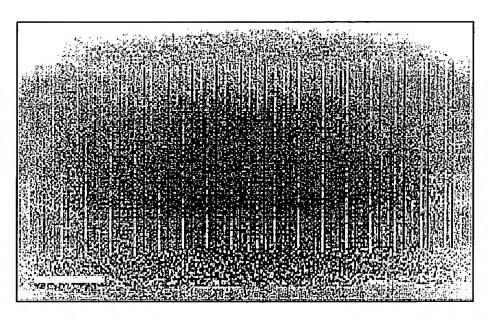


Fig. 13B

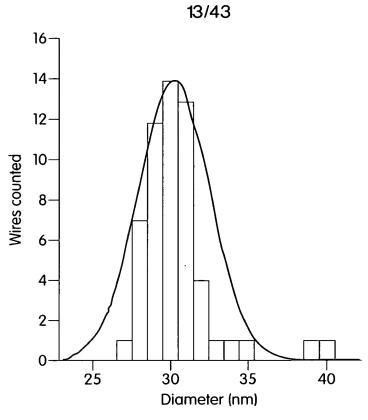


Fig. 14A

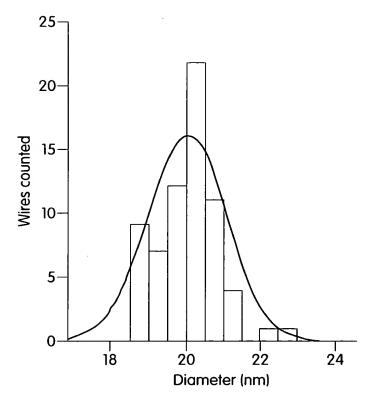


Fig. 14B

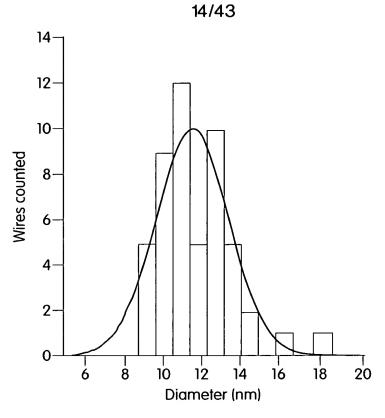


Fig. 14C

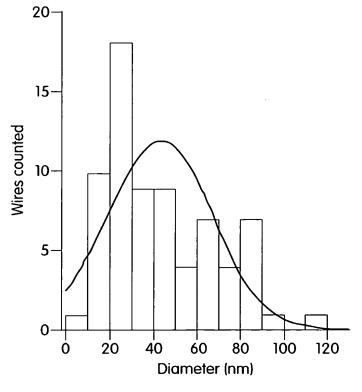


Fig. 14D

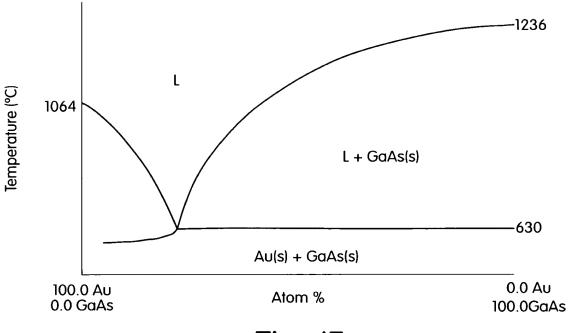


Fig. 15



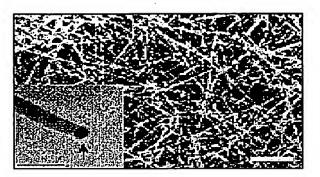


Fig. 16A

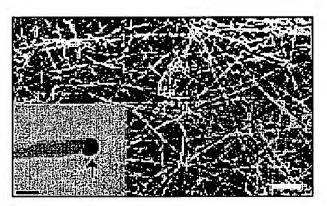


Fig. 16B

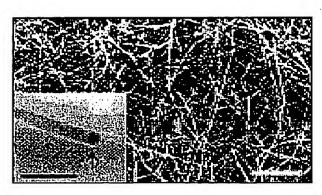


Fig. 16C

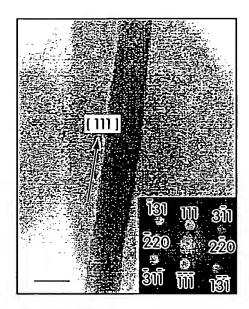


Fig. 17A

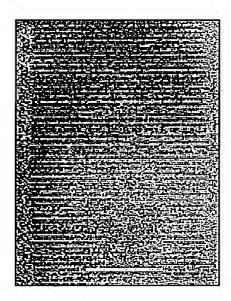


Fig. 17B

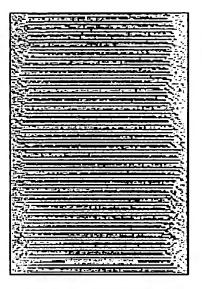


Fig. 17C

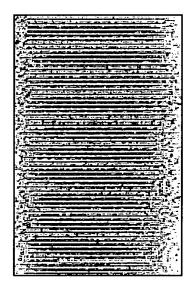


Fig. 17D



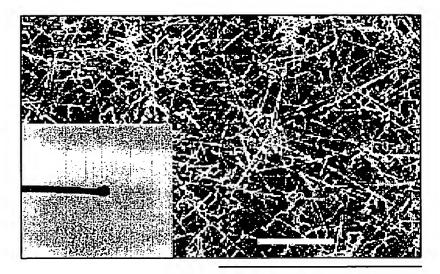


Fig. 18A

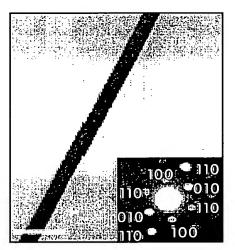


Fig. 18B

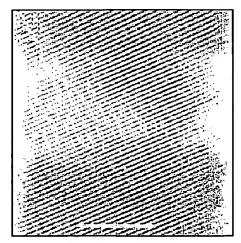


Fig. 18C



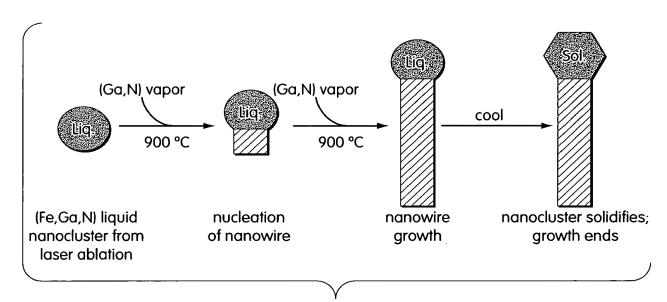


Fig. 19

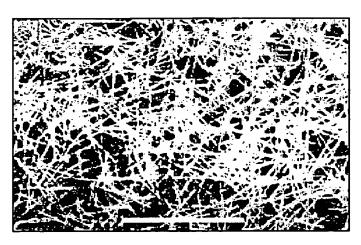


Fig. 20A

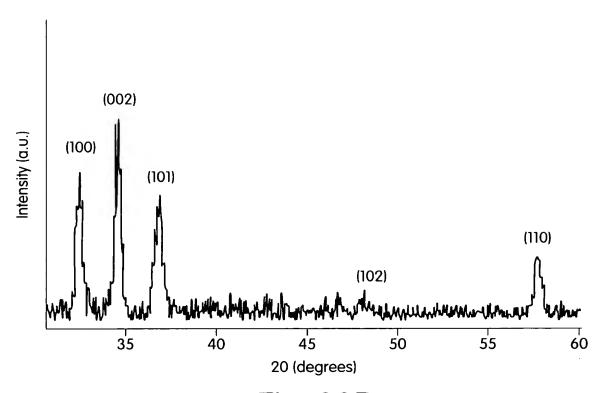


Fig. 20B



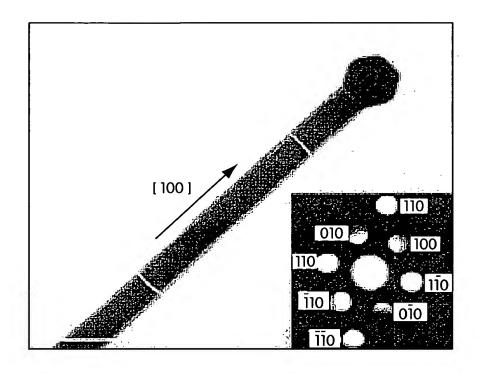


Fig. 21A

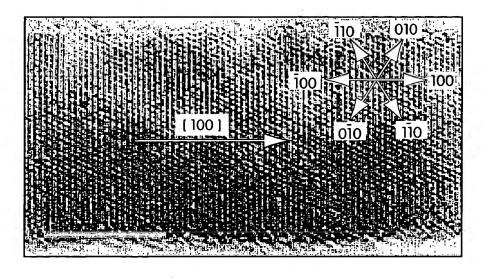


Fig. 21B



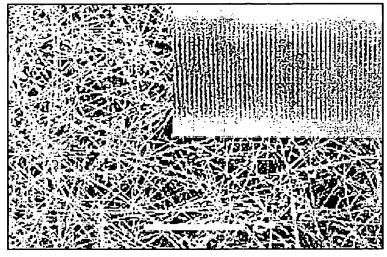


Fig. 22A

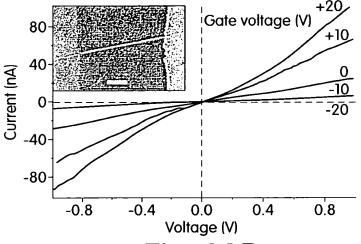
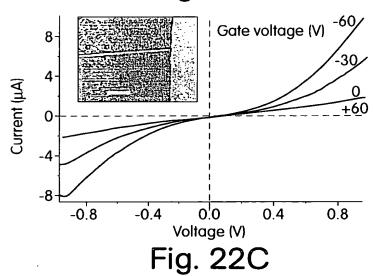


Fig. 22B



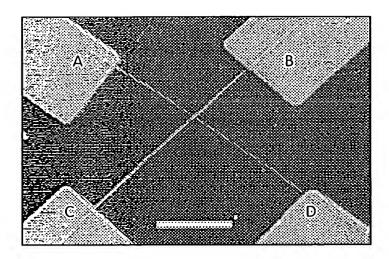


Fig. 23A

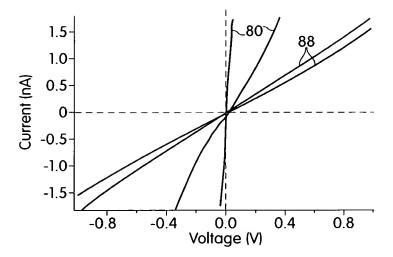


Fig. 23B

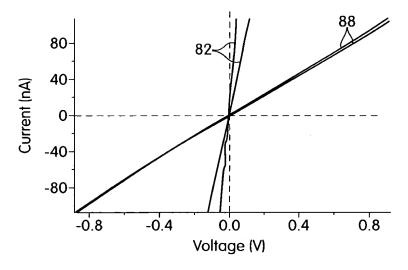


Fig. 23C

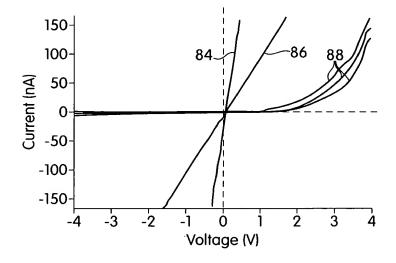


Fig. 23D

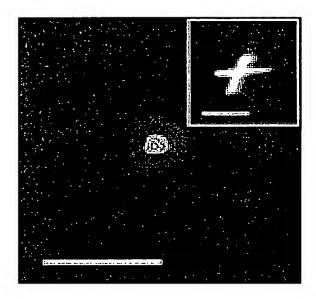


Fig. 24A

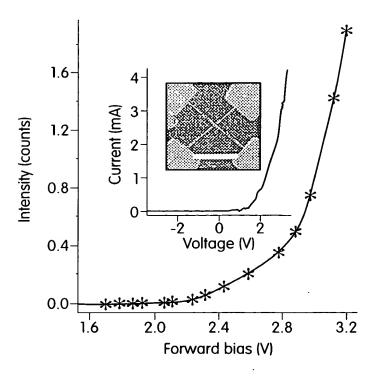
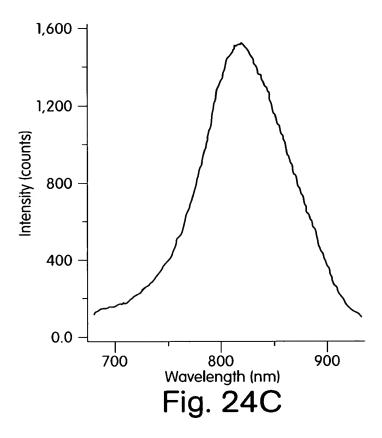
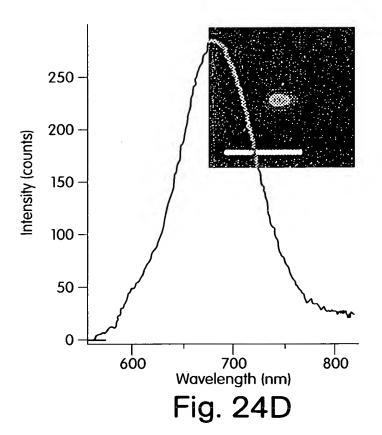


Fig. 24B

υŻ







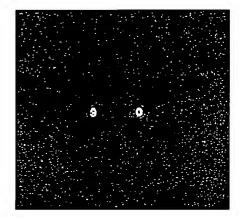


Fig. 25A

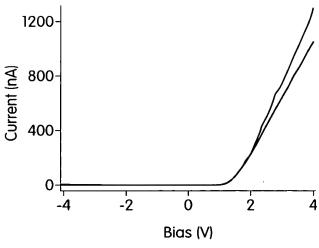


Fig. 25B

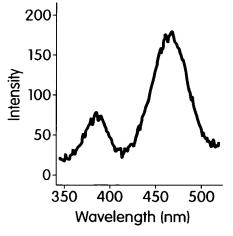


Fig. 25C



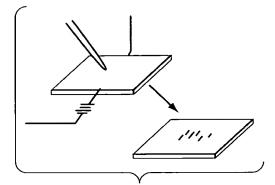


Fig. 26A

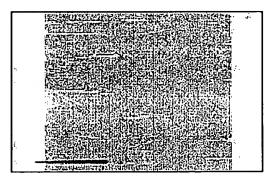


Fig. 26B

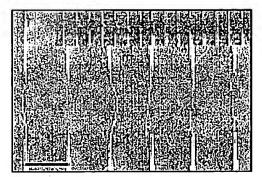


Fig. 26C

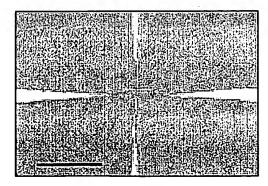


Fig. 26D





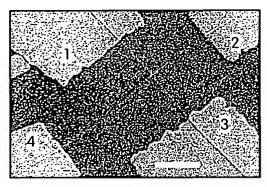


Fig. 27A

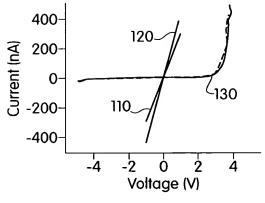


Fig. 27B

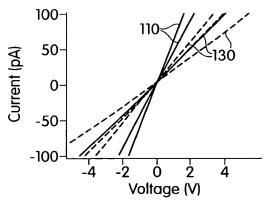


Fig. 27C



31/43

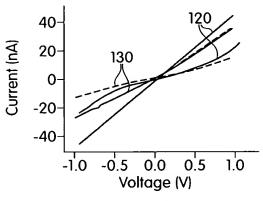


Fig. 27D

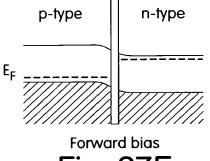


Fig. 27E

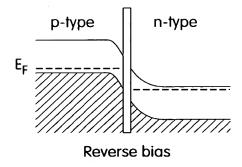


Fig. 27F



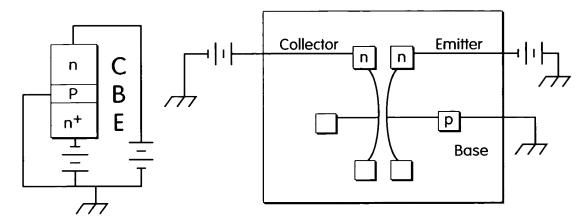


Fig. 28A

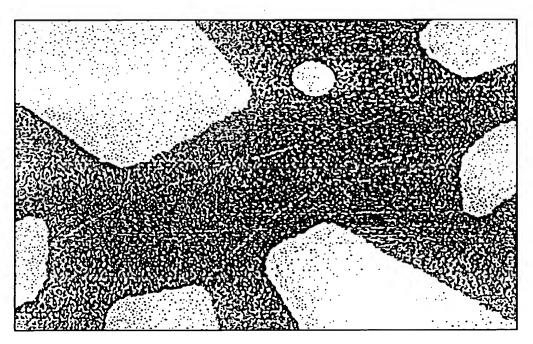
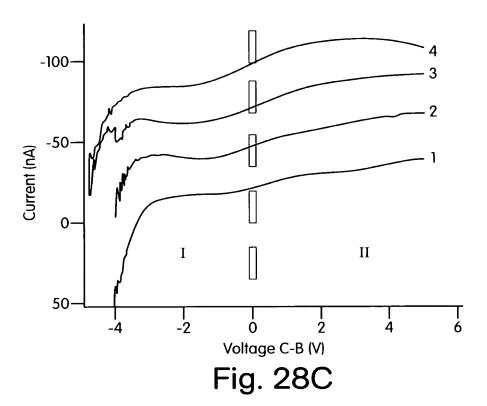


Fig. 28B





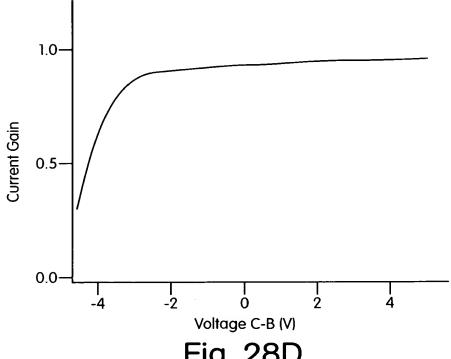


Fig. 28D



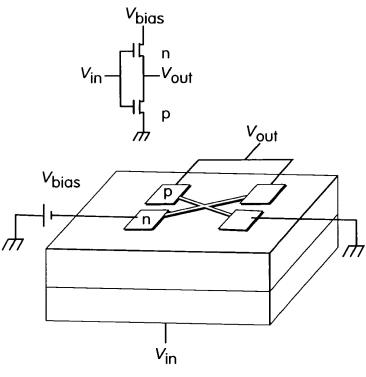


Fig. 29A

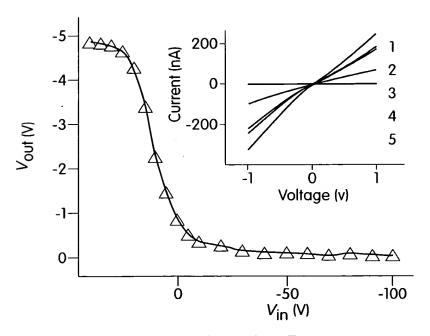


Fig. 29B



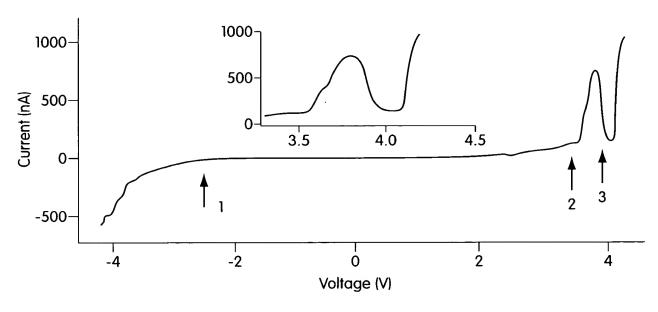


Fig. 29C

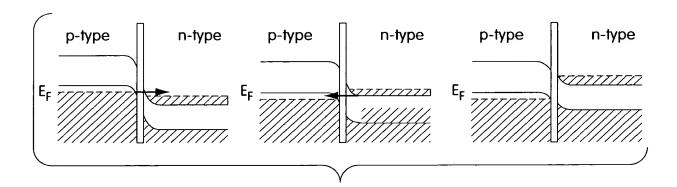
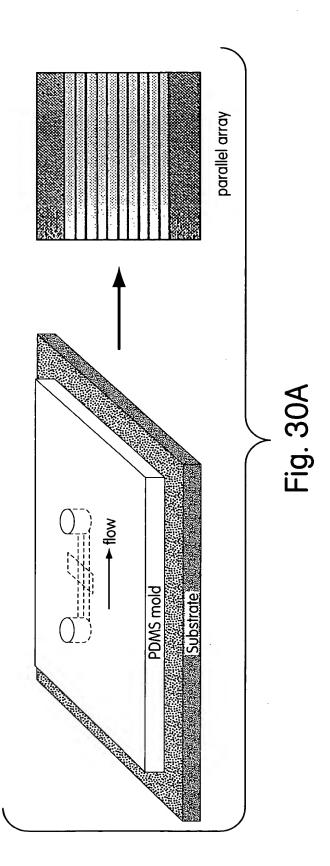


Fig. 29D

OPPEYVE DELECT

Doped Elongated Semiconductors, Growing Such Semiconductors, Devices Including Such .... U.S.S.N. 09/935/776 H00498.70154/TJO/DPM

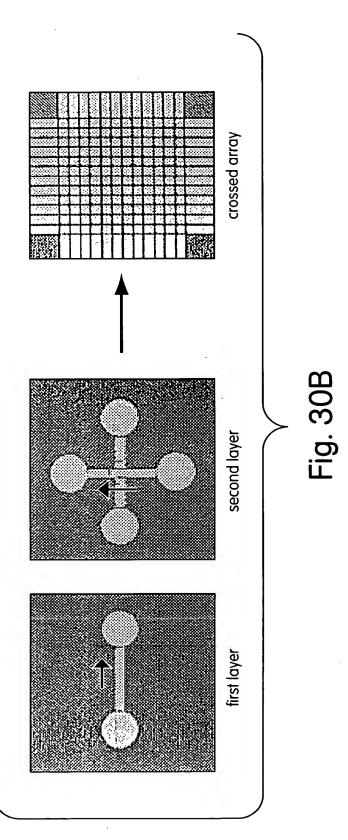
36/43



O9935776 D31608









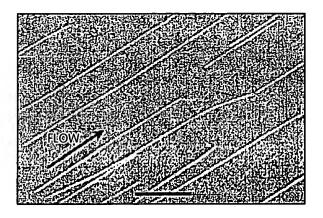


Fig. 31A

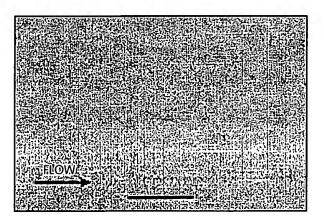
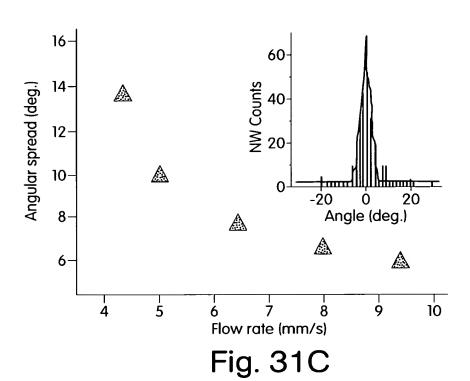


Fig. 31B





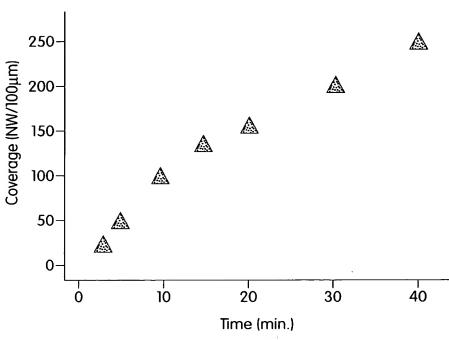


Fig. 31D





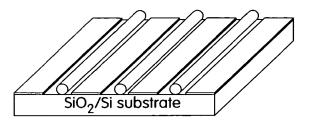


Fig. 32A

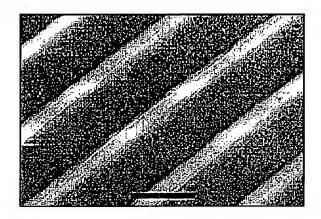


Fig. 32B





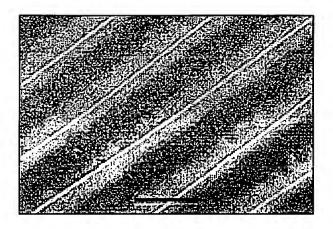


Fig. 32C

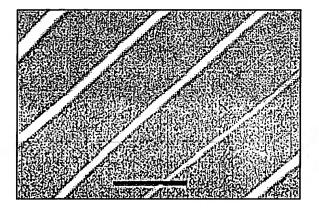


Fig. 32D





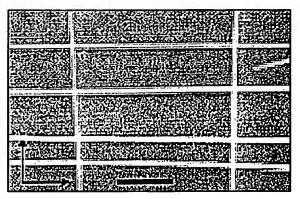


Fig. 33A

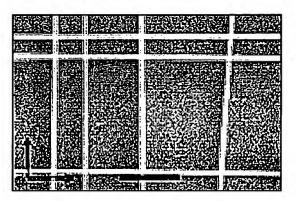


Fig. 33B

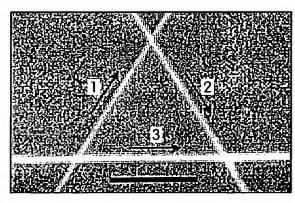


Fig. 33C





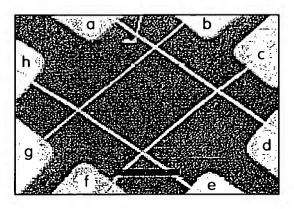


Fig. 33D

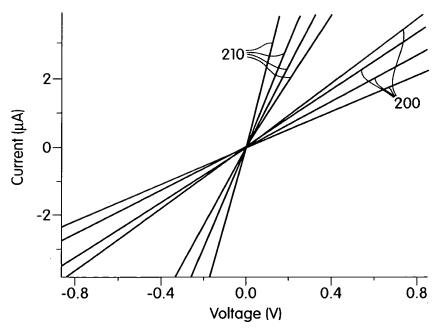


Fig. 33E